



Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	l _D max T _C = +25°C
Q1	201/	21mΩ @ V _{GS} = 10V	14A
QT	30V	32mΩ @ V _{GS} = 4.5V	14A
Q2	-30V	39mΩ @ V _{GS} = -10V	-14A
QZ	-30 V	53mΩ @ V _{GS} = -4.5V	-14A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- Power Management Functions
- DC-DC Converters
- Backlighting

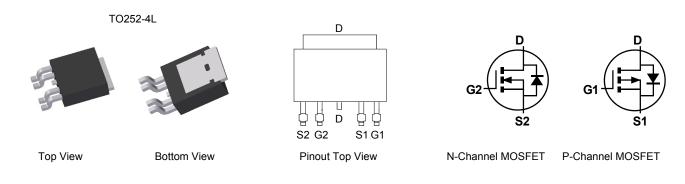
COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Features and Benefits

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TO252-4
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.027 grams (approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3021LK4-13	TO252-4	2500/Tape & Reel

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information

Notes:



>!! = Manufacturer's Marking
C3021L = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 11 = 2011)
WW = Week (01 - 53)



Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	9.4 7.5	A
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _C = +25°C T _C = +70°C	ID	14 14	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)	I _{DM}	70	А	
Avalanche Current, (Notes 7) L = 0.1mH	I _{AS}	16	А		
Avalanche Energy, (Notes 7) L = 0.1mH			E _{AS}	13	mJ

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage	V _{DSS}	-30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	ID	-6.8 -5.3	A
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _C = +25°C T _C = +70°C	ID	-14 -14	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)	I _{DM}	-50	A	
Avalanche Current, (Notes 7) L = 0.1mH		I _{AS}	-16	A	
Avalanche Energy, (Notes 7) L = 0.1mH			E _{AS}	13	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)	T _A = +25°C		2.7		
Total Power Dissipation (Note 6)	T _A = +70°C	P	1.7	W	
Total Dower Discinction (Note 6)	T _C = +25°C	PD	22		
Total Power Dissipation (Note 6)	$T_{\rm C}$ = +70°C		14		
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	$R_{ ext{ heta}}JA$	46	°C///	
Thermal Resistance, Junction to Case (Note 6)	Steady state	$R_{ ext{ heta}JC}$	5.5	°C/W	
Operating and Storage Temperature Range	·	T _{J,} T _{STG}	-55 to +150	°C	

Notes:

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate 7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = 25^{\circ}C$ 8. Short duration pulse test used to minimize self-heating effect. 9. Cuprented by device the transmission of the product testing.

9. Guaranteed by design. Not subject to product testing.

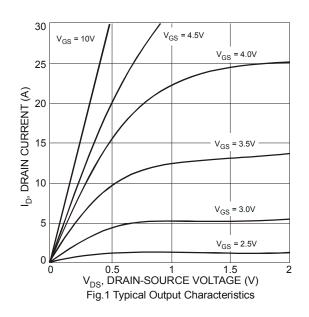


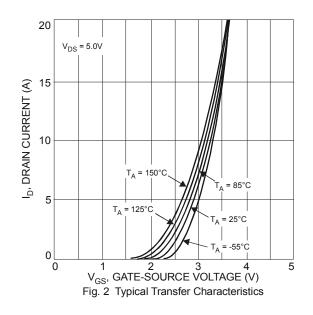
Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	V_{GS} = 0V, I _D = 250µA
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$; I _{DSS}	—	—	1.0	μA	V_{DS} = 30V, V_{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	1	1.5	2.1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	Proven		14	21	mΩ	V _{GS} = 10V, I _D = 7A
	R _{DS(ON)}	—	18	32	11152	V _{GS} = 4.5V, I _D = 5.6A
Forward Transfer Admittance	Y _{fs}	—	8.5	_	S	V _{DS} = 5V, I _D = 7A
Diode Forward Voltage	V_{SD}	_	0.7	1.0	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance Output Capacitance		-	751		pF	
		-	121		pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	110	_	pF	
Gate Resistance	Rg	_	1.5	_	Ω	V _{DS} = 10V, V _{GS} = 0V,f = 1.0MHz
Total Gate Charge (4.5V)	Qg	_	9	_	nC	
Total Gate Charge (10V)	Qg	-	17.4	—	nC	V _{GS} = 10V, V _{DS} = 15V,
Gate-Source Charge	Qgs	-	2.2	—	nC	I _D = 6A
Gate-Drain Charge	Q _{gd}	-	3	—	nC	
Turn-On Delay Time	t _{D(on)}	-	2.5	—	ns	
Turn-On Rise Time Turn-Off Delay Time		—	6.6	—	ns	V _{DD} = 15V, V _{GS} = 10V,
		—	19.0	_	ns	$R_{G} = 6\Omega, R_{L} = 1.8\Omega, I_{D} = 6.7A$
Turn-Off Fall Time	t _{D(off)}	—	6.3	—	ns	7

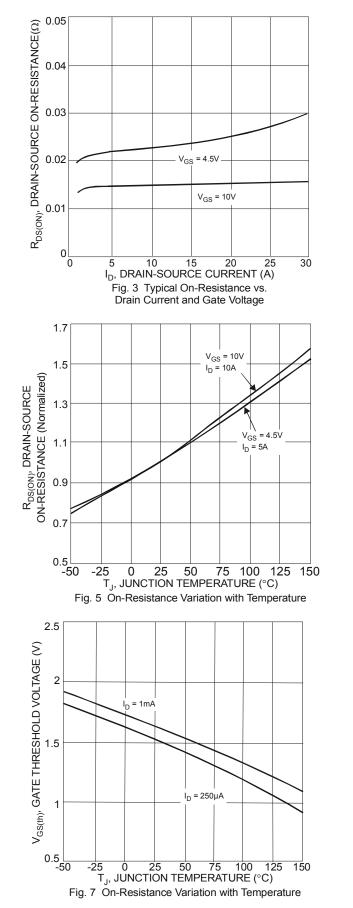
 Notes:
 8. Short duration pulse test used to minimize self-heating effect.

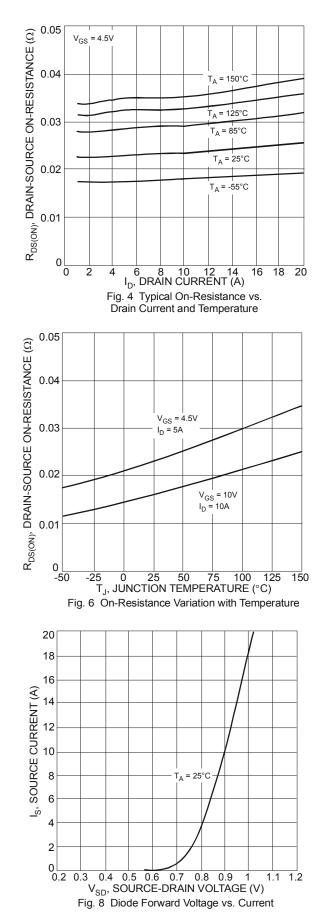
 9. Guaranteed by design. Not subject to product testing.





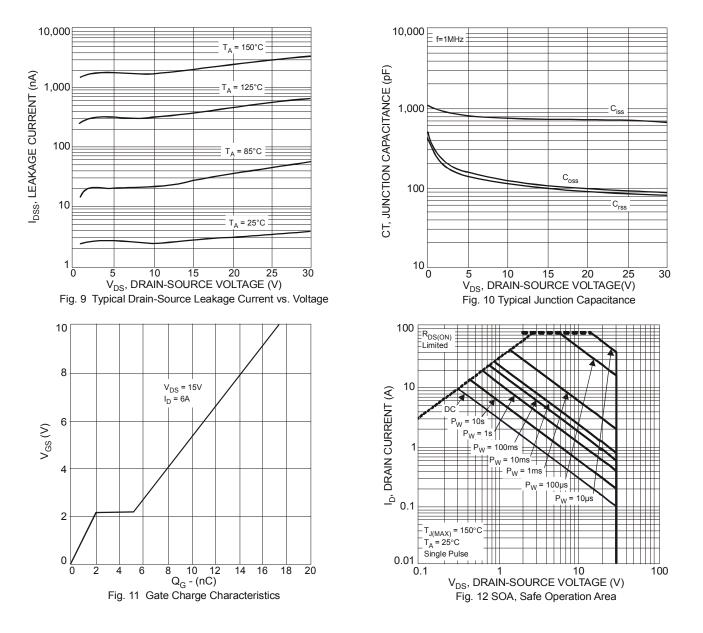








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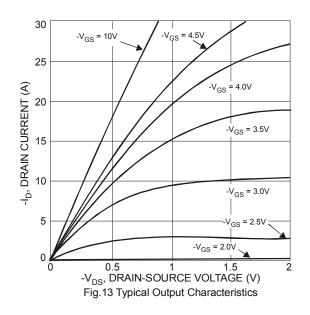


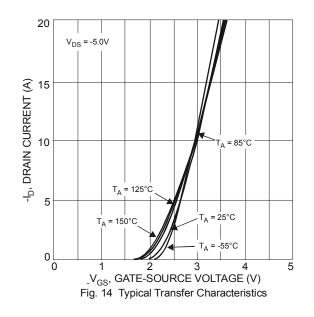


Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

			- / =-	-,		1	1
Characteristic		Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage		BV _{DSS}	-30	—	—	V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current	@T _C = +25°C	IDSS	—	_	-1	μA	V_{DS} = -30V, V_{GS} = 0V
Gate-Source Leakage		I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage		V _{GS(th)}	-1	-1.7	-2.2	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance		D	_	30	39	mΩ	V_{GS} = -10V, I_{D} = -4.3A
Static Drain-Source On-Resistance		R _{DS} (ON)	_	42	53	11122	V_{GS} = -4.5V, I_{D} = -3.7A
Forward Transfer Admittance		Y _{fs}	_	10	_	S	V_{DS} = -5V, I_{D} = -4.3A
Diode Forward Voltage		V_{SD}	_	-0.75	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance		C _{iss}	_	1039	_	pF	
Output Capacitance		Coss	_	144		pF	− V _{DS} = -10V, V _{GS} = 0V, − f = 1.0MHz
Reverse Transfer Capacitance		C _{rss}	_	134		pF	
Gate Resistance		Rg	_	13		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (4.5V)		Qg	_	10.1	—	nC	
Total Gate Charge (10V)		Qg	_	21.1	—	nC	V _{GS} = -10V, V _{DS} = -15V,
Gate-Source Charge		Q _{gs}	_	2.8	—	nC	I _D = -6A
Gate-Drain Charge		Q _{gd}	_	3.2	—	nC	
Turn-On Delay Time		t _{D(on)}	_	10.1	_	ns	
Turn-On Rise Time		tr	_	6.5	_	ns	V _{DS} = -15V, V _{GS} = -10V,
Turn-Off Delay Time		t _{D(off)}	_	50.1	—	ns	$R_G = 6\Omega, I_D = -1A$
Turn-Off Fall Time		t _f	_	22.2	_	ns	7

 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing. Notes:







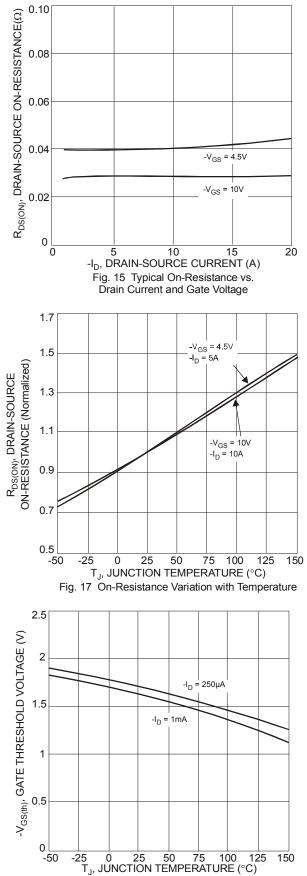


Fig. 19 On-Resistance Variation with Temperature

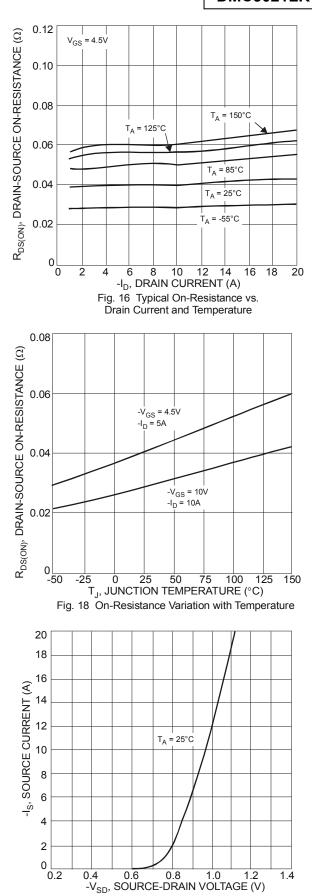
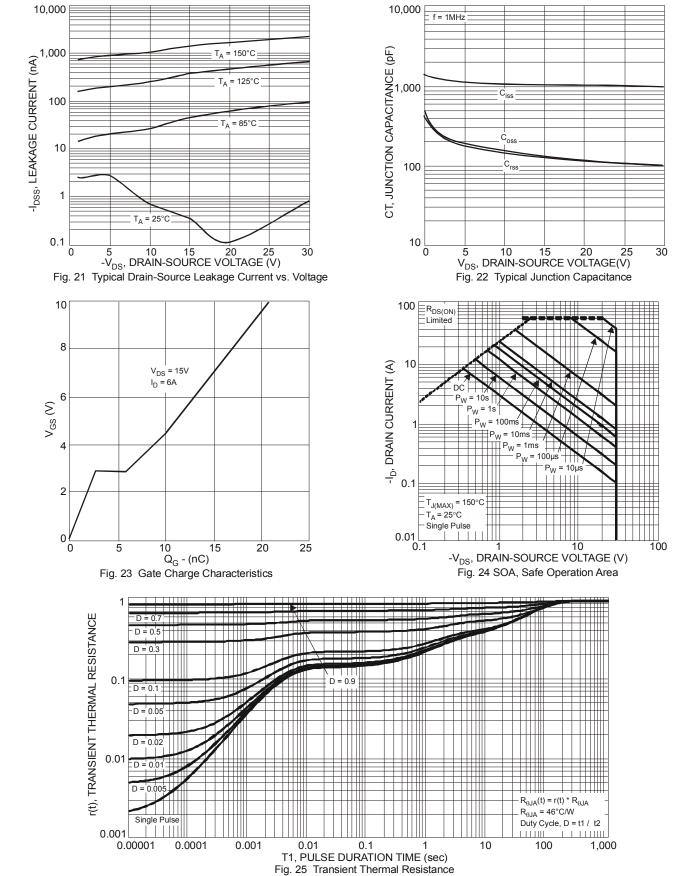


Fig. 20 Diode Forward Voltage vs. Current



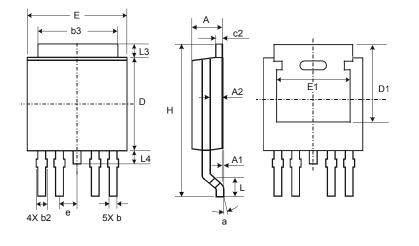
DMC3021LK4





Package Outline Dimensions

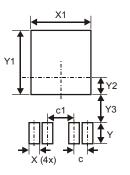
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



ĺ	TO252-4						
Dim	Min	Max	Тур				
Α	2.19	2.39	2.29				
A1	0.00	0.13	0.08				
A2	0.97	1.17	1.07				
b	0.51	0.71	0.583				
b2	0.61	0.79	0.70				
b3	5.21	5.46	5.33				
c2	0.45	0.58	0.531				
D	6.00	6.20	6.10				
D1	5.21	-	-				
е	-	-	1.27				
Ε	6.45	6.70	6.58				
E1	4.32	-	-				
Н	9.40	10.41	9.91				
L	1.40	1.78	1.59				
L3	0.88	1.27	1.08				
L4	0.64	1.02	0.83				
а	0°	10°	_				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.27
c1	2.54
Х	1.00
X1	5.73
Y	2.00
Y1	6.17
Y2	1.64
Y3	2.66



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